

# Thermal Design and Dimensional Drift

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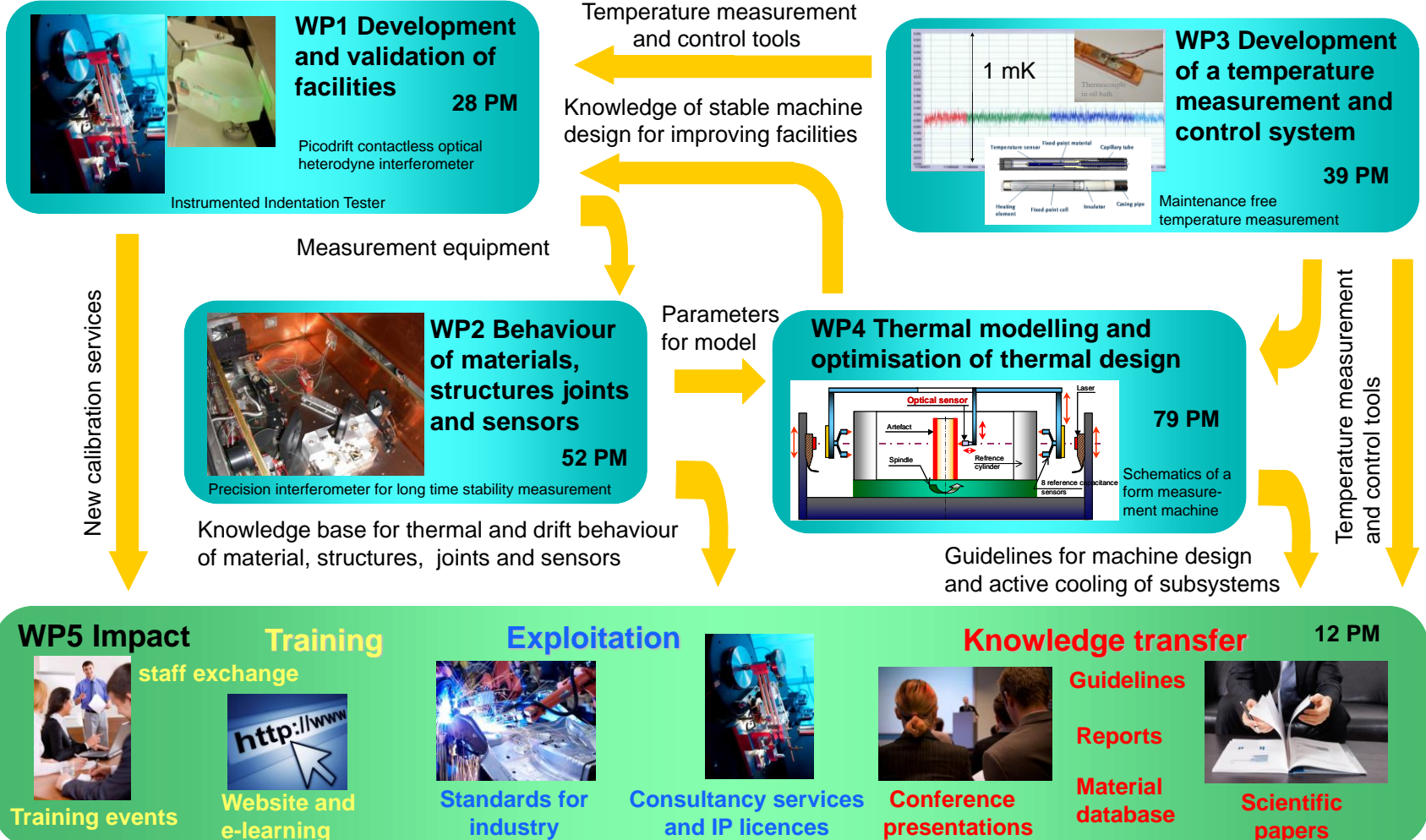
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**EMRP**  
European Metrology Research Programme  
► Programme of EURAMET



The EMRP is jointly funded by the EMRP participating countries within EURAMET and the European Union

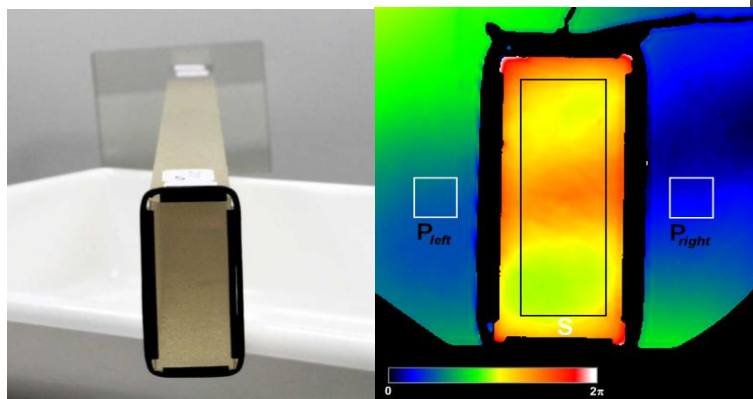
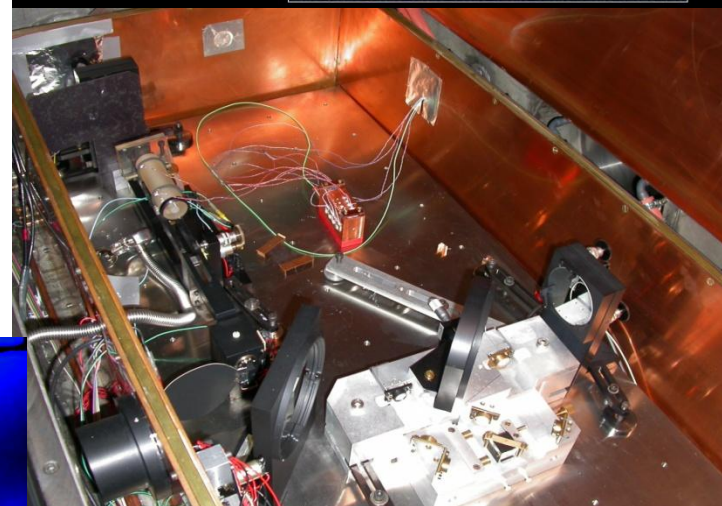
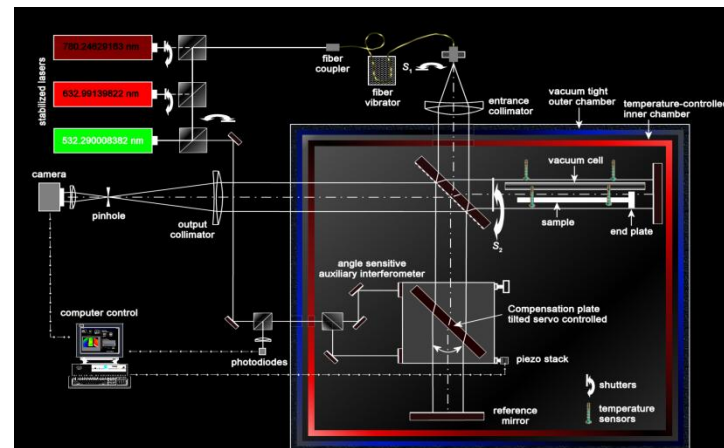


# PTB Ultra Precision Interference Comparator



Objective: Evaluation of thermal expansion and long time stability of materials, joints, sensors and actuators

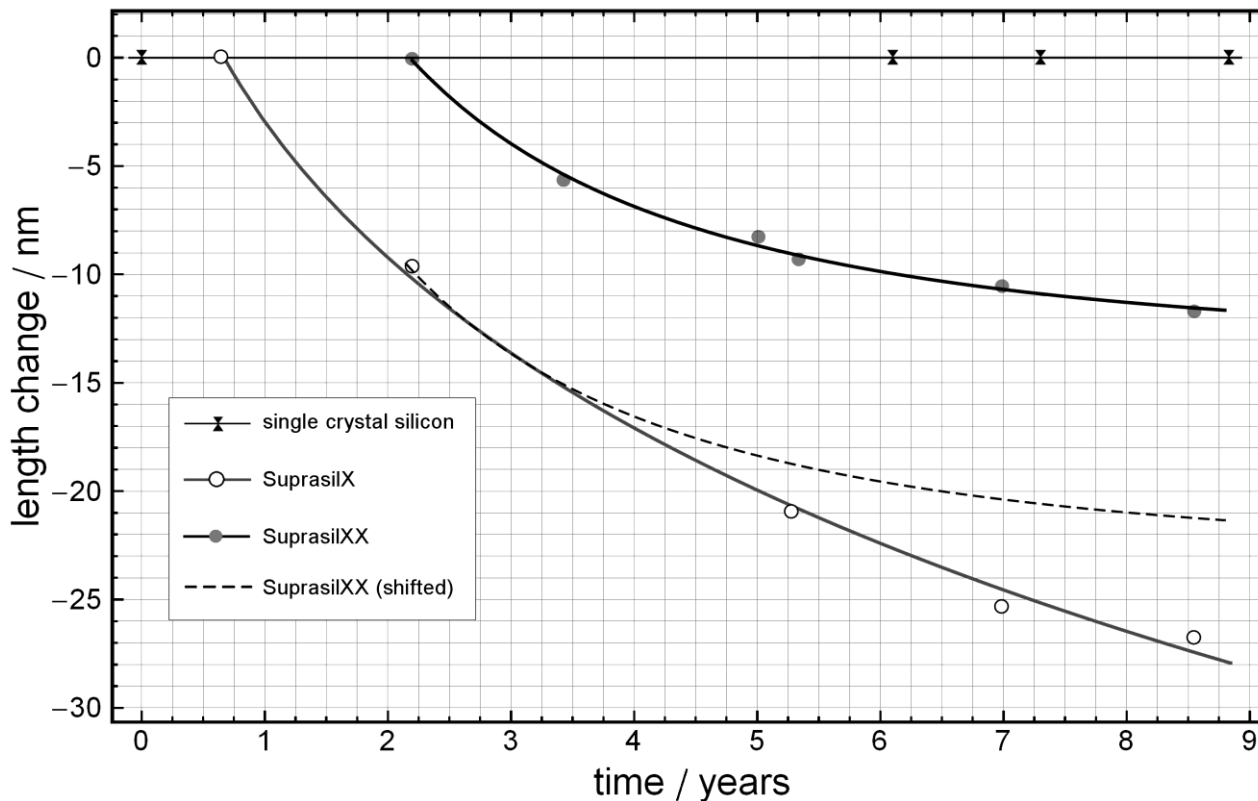
- Absolute measurement of length between parallel surfaces using phase stepping interferometry
- Beam diameter: 60 mm
- Parallelism for highest precision: 4''



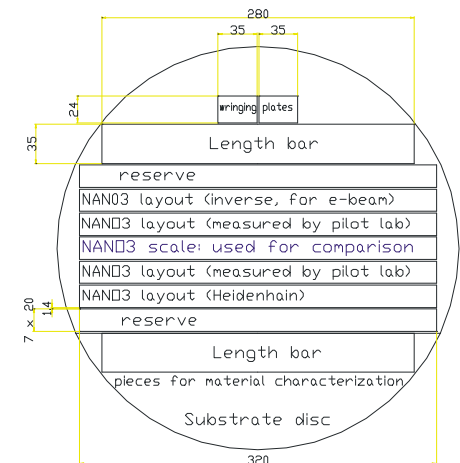
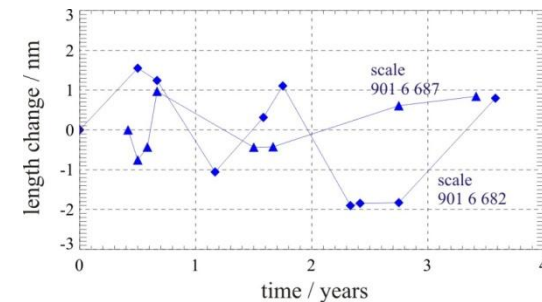
# PTB Ultra Precision Interference Comparator



Results: Long time stability of fused silica and single crystal silicon

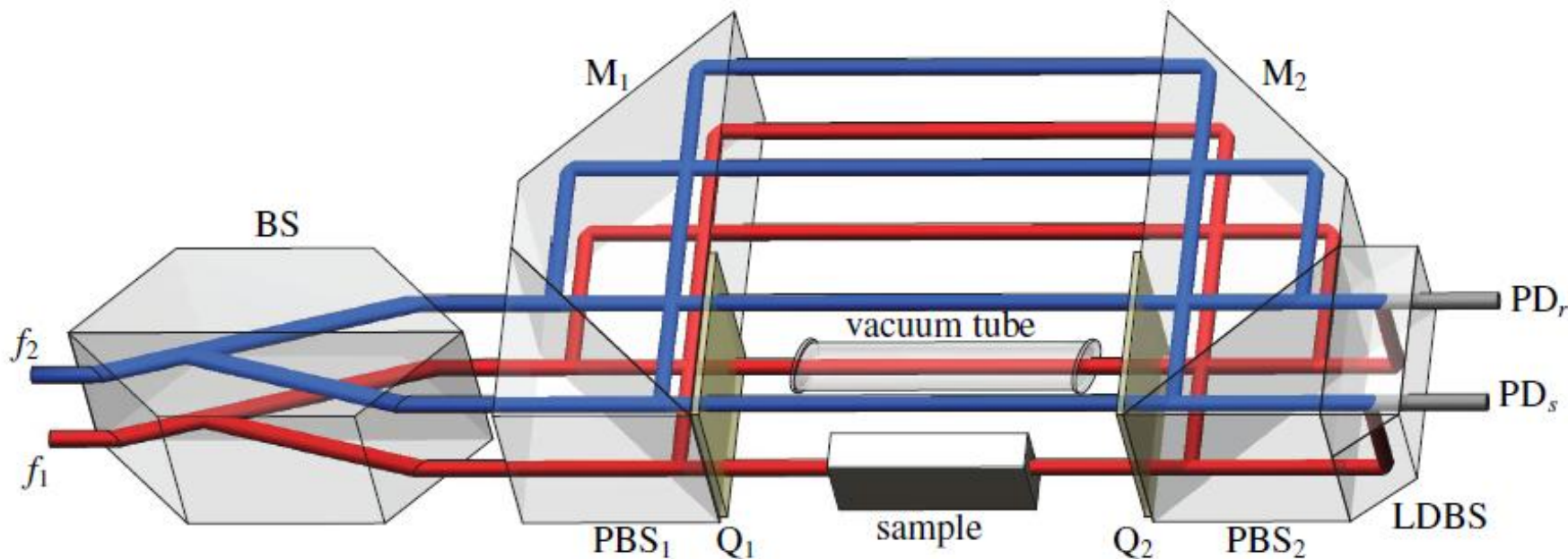
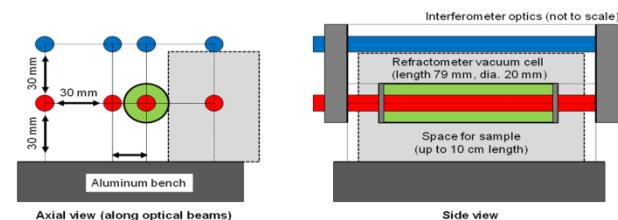


Long time stability of fused silica line scales from same substrate



# VSL Picodrift Interferometer

Objective: Sub 10 pm accuracy evaluation of short and midterm stability of materials, joints, sensors and actuators

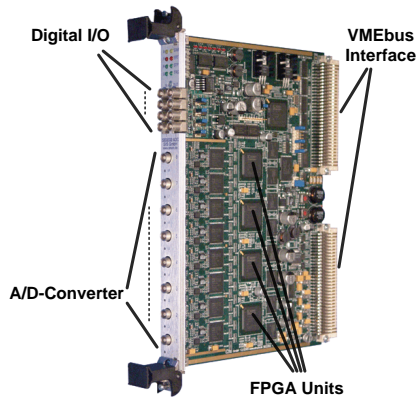


J.D. Ellis, K.-N. Joo, J.W. Spronck, and R.H. Munnig Schmidt,  
“Balanced interferometric system for stability measurements”,  
Appl. Opt. **48**(9), 1733-1740 (2009).

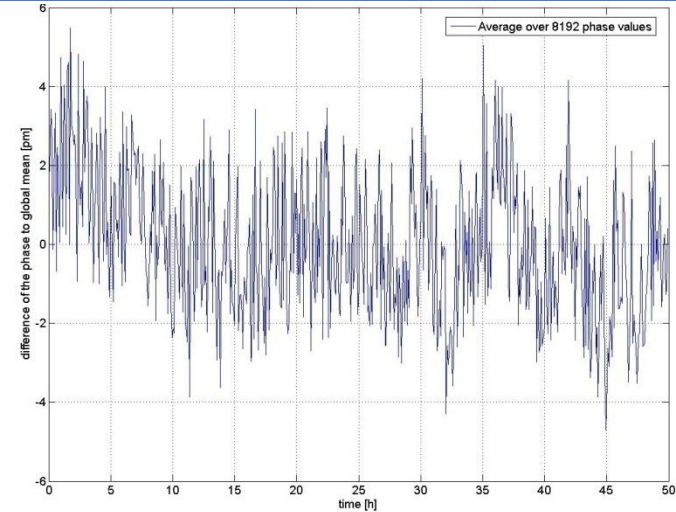
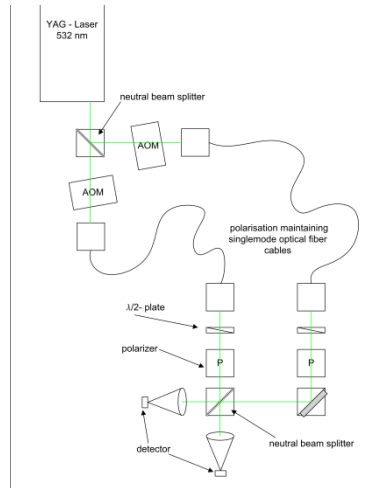
# PTB Heterodyne Phasemeter



Struck SIS 3302  
16 Bit, 100 MHz ADC

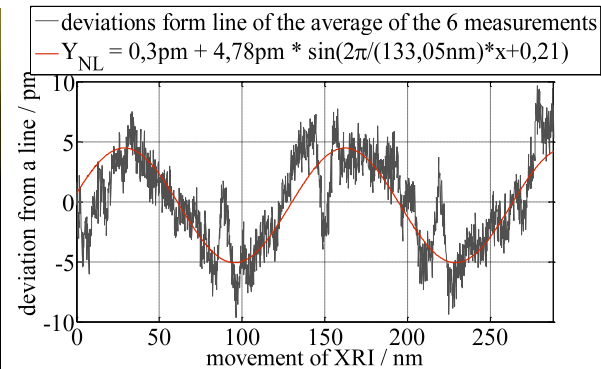
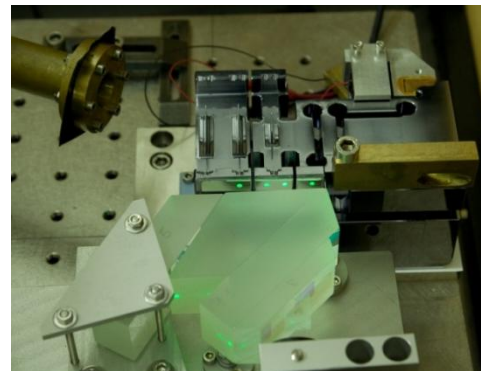
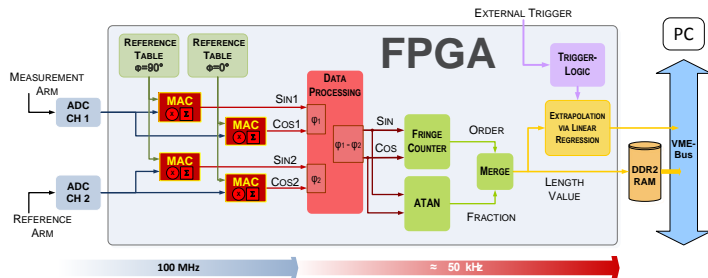


Test setup for stability evaluation



Interpolation nonlinearity below 5 pm shown by comparison with X-ray interferometer

Dual Phase Lock-In Algorithm in FPGA



But due to asymmetry  
2 pm / mK sensitivity

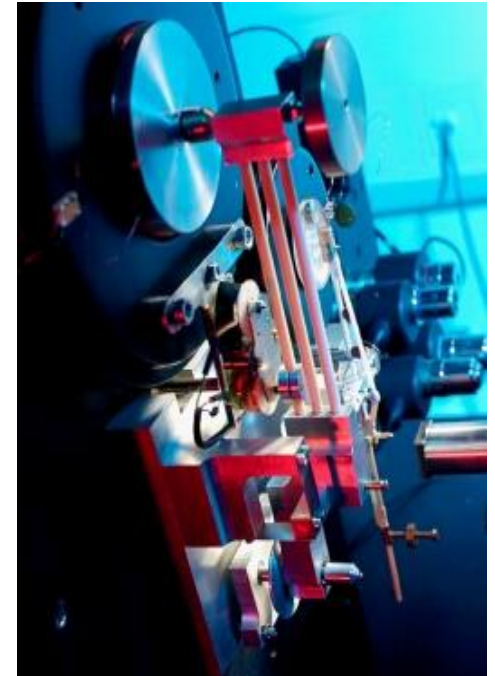


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# Nanoindentation

Objective: mapping of creep and hardness at temperature by nanoindentation.

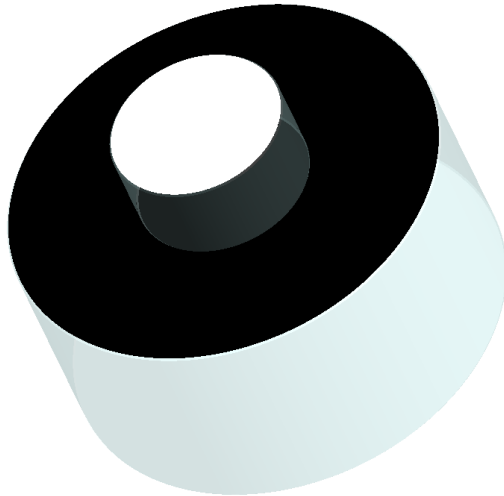
- Procedures to be developed to calibrate the nanoindenter instrument at elevated temperatures.
- Dimensional stability to be evaluated and an uncertainty budget produced.
- Procedures developed to map the mechanical properties as a function of temperature.
- Nanoindentation results compared to those obtained from conventional creep measurements.



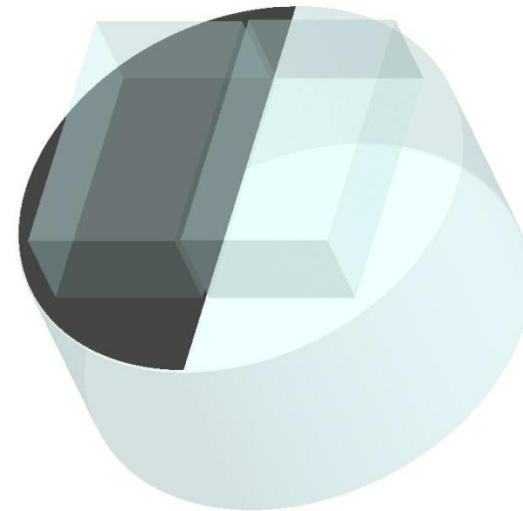
Nanoindentation  
instrumentation

# Demonstration Samples

## Planar Fused Silica Substrates bonded together with 3 different technologies



Demonstrator for one/ two side Interferometry



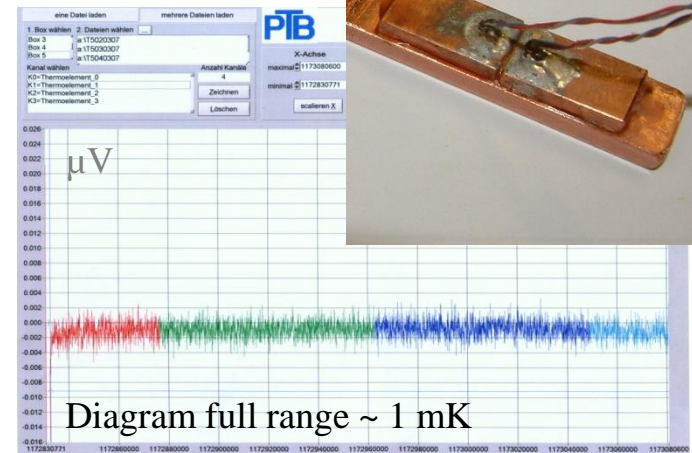
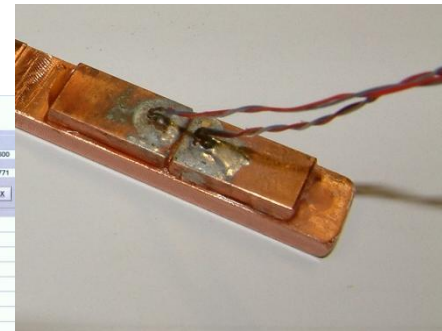
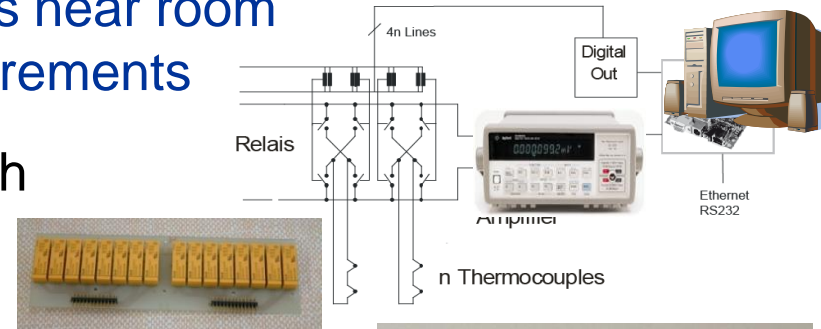
Demonstrator for Nanoindentation  
and one side interferometry  
(One probe wrung on base substrate)



# Thermocouple Measurements

Objective: Evaluation of stress sensitivity of zero point and characteristics of thermocouples near room temperature for maintenance free measurements

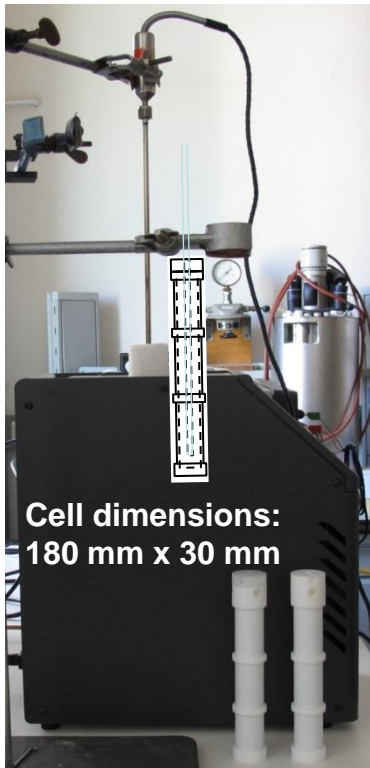
- Thermocouples are lightweight and with no self heating.
  - Direct differential temperature measurement for control of gradients
  - Investigation of 32 thermocouples regarding stability of zero point and characteristics dependence on stress and mounting conditions
- Different materials      Cu/Konstantan, Ni-Cr/Ni-Al, Pt/Rh, ...
  - Different wires          Manufacturer, length and diameters
  - Foil and Thinfilm thermocouples
  - Connectors



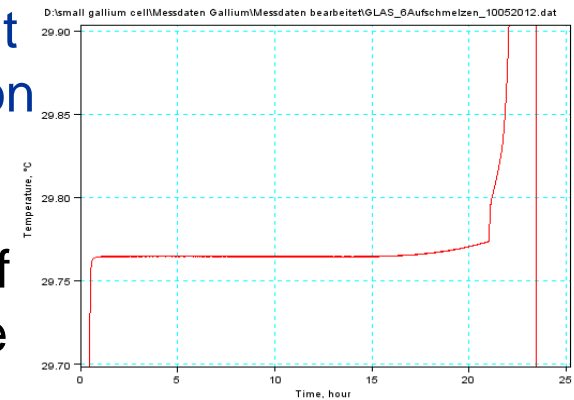
4 Measurements / Min.

# Development of a fixed-point cell (binary Ga-Sn alloy)

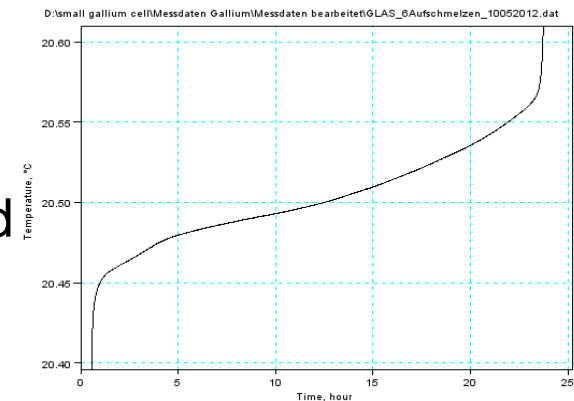
Objective: Development of a miniaturized fixed point cell near room temperature for in machine calibration of Pt-reference thermometers.



- Investigation of the influence of fixed point cell materials on the melting and supercooling behaviour of pure gallium
- Fixed point cell doped with tin to produce an eutectic binary alloy with gallium to get a fixed point temperature at about 20.4°C.
- Find optimum boundary conditions and algorithms for a stable and reproducible detection of melting plateau.



Melting plateau of pure gallium

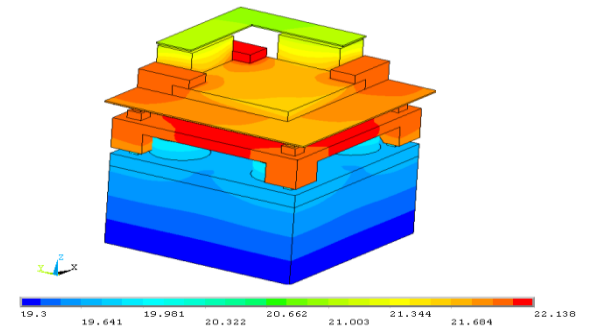


Melting plateau of an eutectic Ga – Sn alloy at about 20.5 °C

# Thermal Modelling and Optimisation

Objective: Thermal modelling and active temperature control for the optimisation of Precision Engineering tools.

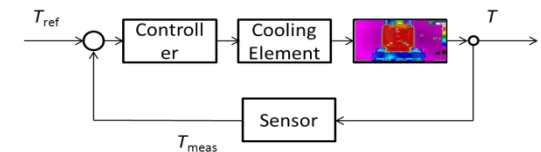
- Thermal modelling of complex engineering equipment and comparison of Modelling approaches (FEM for complex models, *Modal identification method* for reduced models).
- Development of a demonstrator for validation of models and investigation of joint structures
- Development of thermal control algorithms and cooling elements for an exemplarily temperature control of a measuring microscope at the PTB line scale comparator.



Thermal model of the SIOS NMM

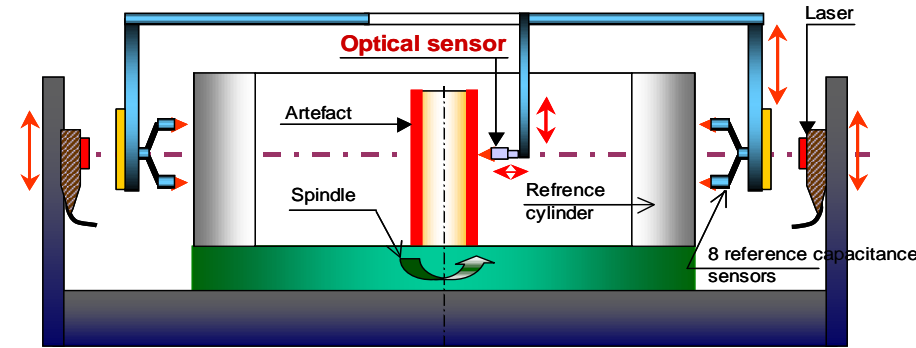
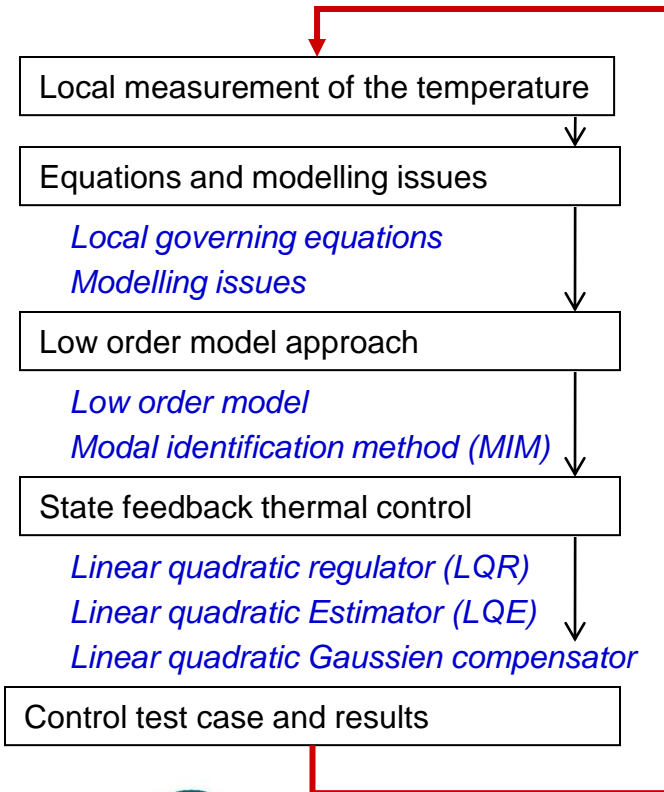


Test setup for the CCD Microscope



# Thermal Modelling and Optimisation

Objective: Exemplarily thermal modelling and optimisation of the LNE form measurement machine.



LNE form measurement machine

